

Full chain Status 6/17/2002

Steps to the full chain

1. SVX4 is working! ~ 10 chips available 6/24
2. L1 prototype hybrid + DJC + Purple Card + SASEQ
 - Finger for L1 hybrid
 - 4 chips per hybrid
 - PCB between chips services SVX4 side bond pad
 - » Layout (by Tom Wesson group) is ready, board available 6/24
 - Hybrid stuffing/bonding at Sidet – need JHA in place
 - Purple Card
 - 2 boards received, at Fermi end of this week?
 - DJC, SASEQ in hand – SASEQ needs reprogramming
 - All parts ready end of June
 - **Working L1 hybrid is a major milestone : end of July**
 - L1 module prototype (hybrid + 2 ELMA L1 sensors)
 - L0 module prototype # 3 (L1 hybrid + 2 Dyconex cables + ELMA L0 sensor)
3. L1 hybrid + DJC + Junction Card + Twisted PC + Adapter Card
 - TPC : All parts here by July 7th, first prototypes ready mid July
 - Adapter Card : need to resolve terminations for single-ended signals
 - **Working full chain : end of August**